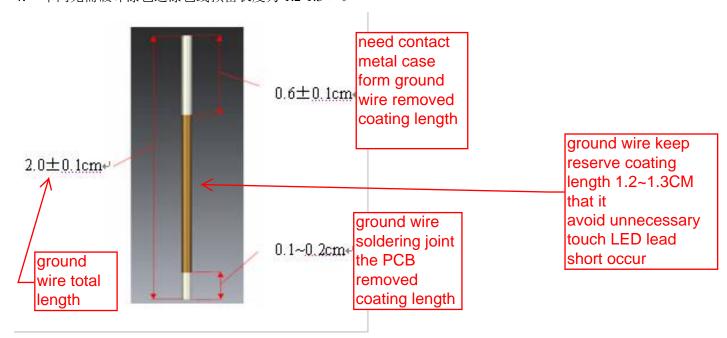


DATE: 2011/08/25 Z (REV:A1)

- 一、 RJL-002LB1 地线破坏长度规范:
- 1. 地线总长度为 2.0±0.1 cm。
- 2. 焊接至 PCB 板端需破坏长度为 0.1-0.2 cm
- 3. 预留至接铁壳端需破坏长度为 0.6±0.1 cm。
- 4. 中间无需破坏漆包之漆包线预留长度为 1.2-1.3 cm。



2.半成品组装胶壳后,在 LED 灯脚处位置贴一张绝缘胶纸,地线摆放位置: 地线须垂直往右端拉摆放在胶壳凹槽处,未被破坏漆包之漆包线须露出胶壳凹槽处 0.2-0.3 cm,以免被破坏漆包之漆包线与 LED 灯脚接触,出现短路现象。



未被破坏漆包之漆包线须露出胶壳凹槽处 0. 2-0. 3 cm

The Semi-finished products assembly process, we modify on LED lamp lead add stick a insulation tape with specific purpose and also requirement when install ground wire in plastic housing shell groove that without remove coating of enamel wire must show glue shell in 0.2 0.3 CM appear.

报告人: 张桂娟 2011.08.25

TAIMAG ELECTRONIC ZHONGSHAN CO.,LTD.

中山煜兴电子有限公司

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